

### WS7803F

### 0.1GHz - 3GHz SP3T Antenna Switch

### **Descriptions**

The WS7803F is a CMOS silicon-on-insulator (SOI), single-pole, three-throw (SP3T) switch. The device is optimized for the applications of WCDMA/LTE receiver and antenna switch for multimode systems. The high linearity performance and low insertion loss make the device an ideal choice for WCDMA/LTE handset and data card applications. The WS7803F switch is provided in a compact Land Grid Array (LGA) 1.15 x 1.15 mm² package.

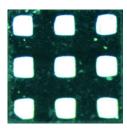
### **Features**

- Small, low profile package 1.15mm x 1.15mm x 0.45mm
- Working frequency up to 3GHz
- · Very low insertion loss
- Excellent isolation performance
- Low power consumption
- Exceptional linearity performance for WCDMA/LTE application
- Low harmonic generation
- Very good ESD performance

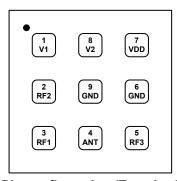
### **Applications**

- Cell phones
- Tablets
- Other RF front-end modules

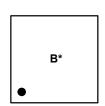
### http//:www.sh-willsemi.com



LGA 1.15X1.15-9L (Bottom view)



Pin configuration (Top view)



B = Device code

\* = Month code (A~Z)

### Marking(Top view)

#### Order information

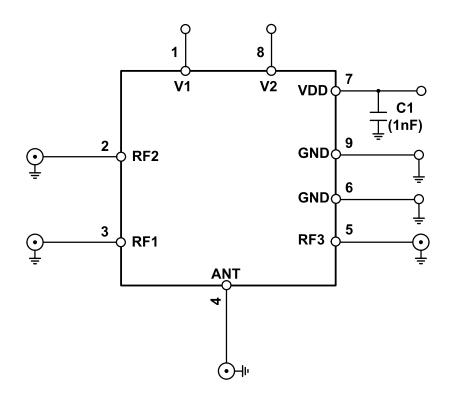
Device	Package	Shipping
WS7803F-9/TR	LGA 1.15X1.15-9L	3000/Reel&Tape



# Pinning information

Pin	Function	Description	Transparent top view	
1	V1	DC control voltage1		
2	RF2	RF port 2	1 8 7	
3	RF1	RF port 1	$\begin{array}{c cccc} v_1 & v_2 & v_{DD} \end{array}$	
4	ANT	RF common (antenna) port		
5	RF3	RF port 3		
6	GND	Ground		
7	VDD	DC power supply	3 RF1 ANT FF3	
8	V2	DC control voltage2	RF1 ANT RF3	
9	GND	Ground		

# **Application information**





## **Recommended operating conditions**

Parameters	Conditions	Specifications			Unit
		Min.	Тур.	Max.	
ESD Rating					
ESD All Pins	HBM, JESD22-A114			1000	V
Power Supply					
Power Supply Voltage	Operating Voltage	2.4	2.8	3.0	V
Power Supply Current	VDD≤3.0V	20	28	40	μΑ
Control Voltage					
Logic Control "Low"		0	0	0.3	V
Logic Control "High"		1.2	1.8	2.7	V
RF Impedance					
RF Port Input and Output Impedance			50		Ω

# Absolute maximum ratings

Maximum ratings are absolute ratings, exceeding only one of these values may cause irreversible damage to the integrated circuit.

Items	Value	Unit
VDD Voltage	-0.3 to +3.0	V
Control Voltage	-0.3 to +2.7	V
Maximum Input Power @ RF ports	26@0.88GHz, 32@2.0GHz	dBm
Operation Temperature	-40 to +85	°C
Storage Temperature	-65 to +150	°C

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## **Characteristics (RF spec)**

Normal test condition unless other-wise stated. All unused ports are  $50\Omega$  terminated. VDD=2.8V, Temp=+25°C.  $P_{IN}$ =0dBm.

Parameters	Conditions	Sp	Specifications			
		Min.	Тур.	Max.		
Insertion Loss (RF1/RF2/RF3)	0.1GHz to 1.0GHz 1.0GHz to 2.0GHz 2.0GHz to 2.7GHz		0.40 0.45 0.50	0.55 0.60 0.65	dB	
Isolation (ANT to RF1/RF2/RF3)	0.1GHz to 1.0GHz 1.0GHz to 2.0GHz 2.0GHz to 2.7GHz	32 25 20			dB	
Return Loss (ANT/RF1/RF2/RF3)	0.1GHz to 1.0GHz 1.0GHz to 2.0GHz 2.0GHz to 2.7GHz	24 20 18			dB	
Second Harmonics (RF1/RF2/RF3)	P <sub>IN</sub> =+26dBm@0.88G		80		dBc	
Third Harmonics (RF1/RF2/RF3)	P <sub>IN</sub> =+26dBm@0.88G		66		dBc	
0.1dB Compression Point (RF1/RF2/RF3)	@0.88GHz @2.00GHz		24 30		dBm	
3 <sup>rd</sup> Order Input Intercept Point (RF1/RF2/RF3)	$P_2$ = +20dBm, $P_1$ = -15dBm, Note 1		55		dBm	

Note 1:  $f_2$ =836.5MHz,  $f_1$ =791.5MHz,  $f_{\text{IMD3}}$ =881.5MHz

# **Truth Table for Operation**

Mode	V1	V2
RF1	1	0
RF2	1	1
RF3	0	1

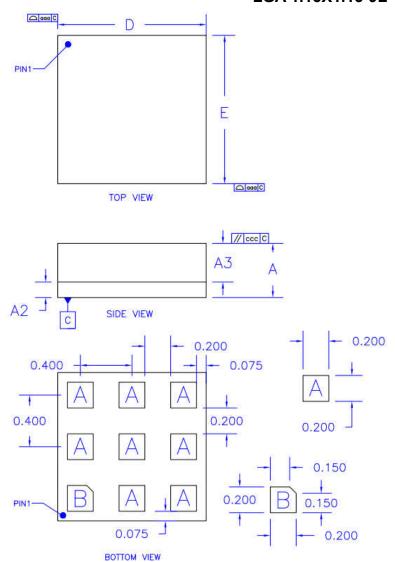
Note: Any state other than that described in this Table places the switch into an undefined state. An undefined state will not damage the device.

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# Package outline dimensions

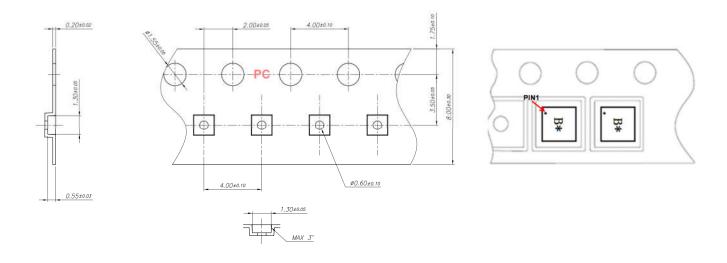
## LGA 1.15X1.15-9L

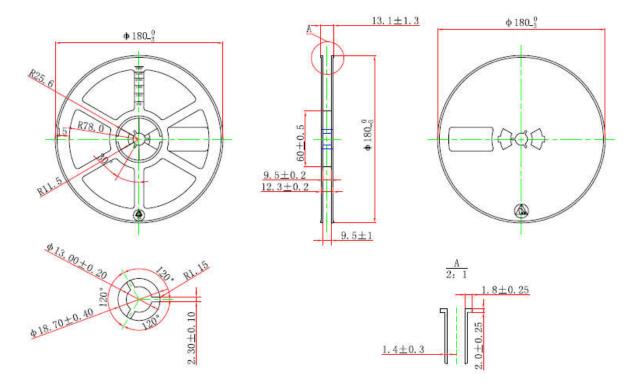


SYMBOL	MILLIMETER			
	MIN	NOR	MAX	
Α	0.40	0.45	0.50	
A2	0.09	0.12	0.15	
A3	0.31	0.33	0.35	
D	1.10	1.15	1.20	
E	1.10	1.15	1.20	
aaa		0.10		
ccc	0.05			



## Tape reel information





#### Notes:

- 1. 10 sprocket hole pitch cumulative tolerance ± 0.2
- 2. Camber not to exceed 1mm in 250mm
- 3. Material: PolyCarbonate
- 4. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
- 6. Pocket center and pocket hole center must be same position.
- 7. ESD: 10E5~10E9